

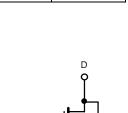
N-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	I _D (A) ^d	Q _g (Typ.)			
60	0.025 at V _{GS} = 10 V	7.6	10.5 nC			
00	0.035 at V _{GS} = 4.5 V	6.5	10.5110			

D D

SO-8

Top View





FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Power MOSFET
- Optimized for "Low Side" Synchronous Rectifier Operation
- 100 % R_g and UIS Tested



ROHS COMPLIANT HALOGEN FREE

APPLICATIONS

CCFL Inverter

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage	V _{DS}	60			
Gate-Source Voltage	V _{GS}	± 20	V		
	T _C = 25 °C		7.6 ^a		
Continuous Drain Current (T _{.I} = 150 °C)	T _C = 70 °C	1 ,	6.8		
Continuous Diam Current (1, = 150 °C)	T _A = 25 °C	l _D	6.1 ^{b, c}		
	T _A = 70 °C		4.8 ^{b, c}		
Pulsed Drain Current	I _{DM}	25	Α		
Continuous Course Davis Diada Current	T _C = 25 °C		4.2		
Continuous Source-Drain Diode Current	T _A = 25 °C	- I _S	2.1 ^{b, c}		
Avalanche Current	1 0411	I _{AS}	15		
Single-Pulse Avalanche Energy	L = 0.1 mH	E _{AS}	11.2	mJ	
	T _C = 25 °C		5		
Mandagoro Brancia di a	T _C = 70 °C		3.2	10/	
Maximum Power Dissipation	T _A = 25 °C	P _D	2.5 ^{b, c}	W	
	T _A = 70 °C	1	1.6 ^{b, c}		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	- 55 to 150	°C		

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	38	50	°C/W	
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	20	25	1 0/00	

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under Steady State conditions is 85 °C/W.



Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	60			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	J 250		55		\//90	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = 250 μA		- 6.3		mV/°C	
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2		2.5	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zara Cata Valtaga Drain Current	I _{DSS}	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$		1			
Zero Gate Voltage Drain Current		$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10	μΑ	
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α	
D : 0	В	V _{GS} = 10 V, I _D = 4.6 A	0.02			0	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, I_D = 4.2 \text{ A}$		0.035		Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_D = 4.6 \text{ A}$		20		S	
Dynamic ^b							
Input Capacitance	C _{iss}			1100		pF	
Output Capacitance	C _{oss}	$V_{DS} = 30 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		90			
Reverse Transfer Capacitance	C _{rss}			55			
Total Cata Charga	0	$V_{DS} = 30 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 4.6 \text{ A}$		21	32	nC	
Total Gate Charge	Q _g			10.5	16		
Gate-Source Charge	Q_{gs}	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 4.6 \text{ A}$		3.5			
Gate-Drain Charge	Q_{gd}			4.2			
Gate Resistance	R_{g}	f = 1 MHz		3.3	5	Ω	
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	t _r	V_{DD} = 30 V, R_L = 5.4 Ω		150	225	1	
Turn-Off DelayTime	t _{d(off)}	$I_D\cong 5.6$ A, V_{GEN} = 4.5 V, R_g = 1 Ω		20	30		
Fall Time	t _f			60	90	20	
Turn-On Delay Time	t _{d(on)}			10	15	ns	
Rise Time	t _r	V_{DD} = 30 V, R_L = 5.4 Ω		15	25		
Turn-Off DelayTime	t _{d(off)}	$I_D\cong 5.6$ A, V_{GEN} = 10 V, R_g = 1 Ω		25	40		
Fall Time	t _f			10	15		
Drain-Source Body Diode Characterist	ics						
Continous Source-Drain Diode Current	I _S	T _C = 25 °C			4.2	Α	
Pulse Diode Forward Current ^a	I _{SM}				25	A	
Body Diode Voltage	V_{SD}	I _S = 2 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			25	50	ns	
Body Diode Reverse Recovery Charge	Q_{rr}	I _F = 5.5 A, dl/dt = 100 A/μs, T _J = 25 °C		25	50	nC	
Reverse Recovery Fall Time	t _a			19		20	
Reverse Recovery Rise Time	t _b			6		ns	

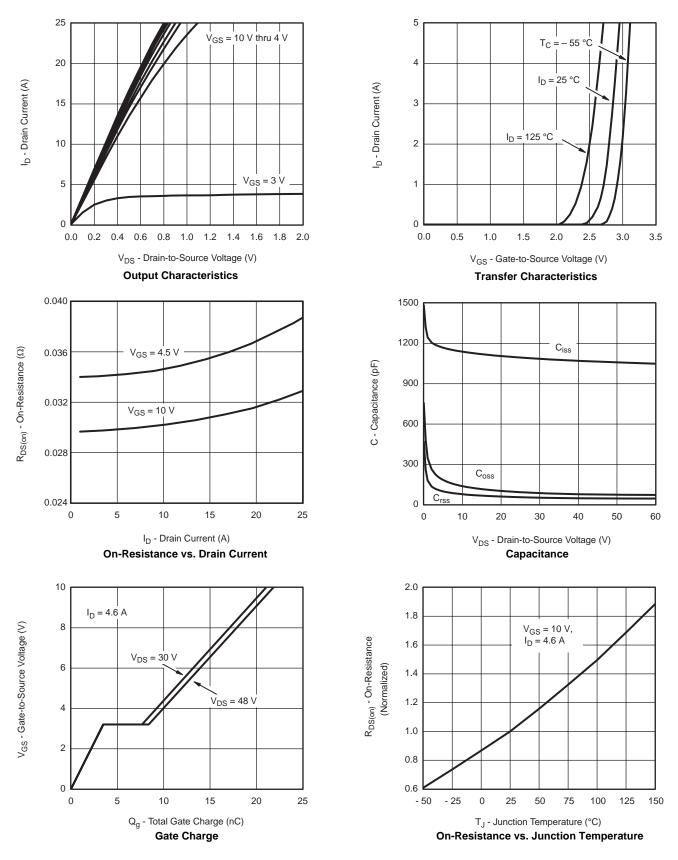
Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

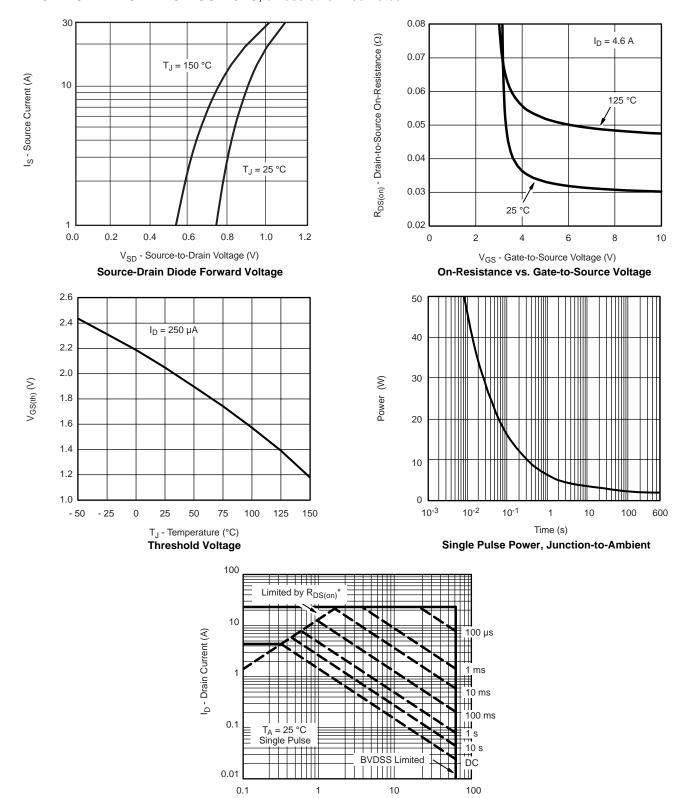
a. Pulse test; pulse width \leq 300 μ s, duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.





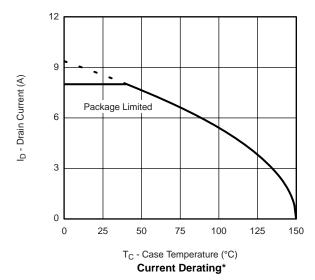


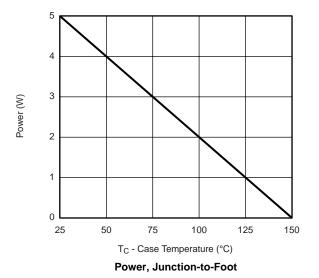


* V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified Safe Operating Area

V_{DS} - Drain-to-Source Voltage (V)

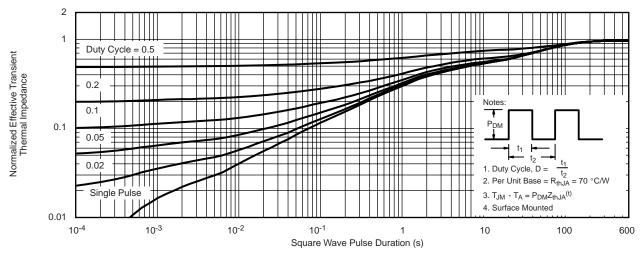




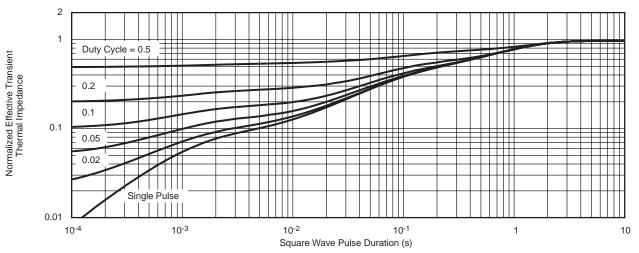


^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit





Normalized Thermal Transient Impedance, Junction-to-Ambient



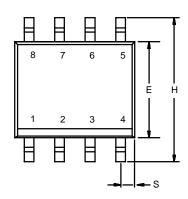
Normalized Thermal Transient Impedance, Junction-to-Foot

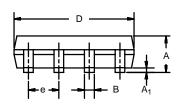
服务热线:400-655-8788

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INC	HES		
DIM	Min	Max	Min	Max		
Α	1.35	1.75	0.053	0.069		
A ₁	0.10	0.20	0.004	0.008		
В	0.35	0.51	0.014	0.020		
С	0.19	0.25	0.0075	0.010		
D	4.80	5.00	0.189	0.196		
E	3.80	4.00	0.150	0.157		
е	1.27 BSC		0.050 BSC			
Н	5.80	6.20	0.228	0.244		
h	0.25	0.50	0.010	0.020		
L	0.50	0.93	0.020	0.037		
q	0°	8°	0°	8°		
S	0.44	0.64	0.018	0.026		
FCN: C-06527-Rev I 11-Sen-06						

ECN: C-06527-Rev. I, 11-Sep-06

DWG: 5498



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)



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